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April 1st, 2010 Renesas Electronics Corporation

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MOS FIELD EFFECT TRANSISTOR 2SK3458

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

The 2SK3458 is N-channel DMOS FET device that features a low gate charge and excellent switching characteristics, designed for high voltage applications such as switching power supply.

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SK3458	TO-220AB
2SK3458-S	TO-262
2SK3458-ZK	TO-263

FEATURES

- Low gate charge
 Qg = 25 nC TYP. (VDD = 450 V, Vgs = 10 V, ID = 6.0 A)
- Gate voltage rating ±30 V
- Low on-state resistance
 R_{DS(on)} = 2.2 Ω MAX. (V_{GS} = 10 V, I_D = 3.0 A)
- · Avalanche capability ratings
- Surface mount package available

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vgs = 0 V)	Voss	800	V
Gate to Source Voltage (Vps = 0 V)	Vgss	±30	V
Drain Current (DC) (Tc = 25°C)	I _{D(DC)}	±6.0	Α
Drain Current (pulse) Note1	D(pulse)	±24	Α
Total Power Dissipation (T _A = 25°C)	P _{T1}	1.5	W
Total Power Dissipation (Tc = 25°C)	P _{T2}	100	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note2	las	6.0	Α
Single Avalanche Energy Note2	Eas	66.5	mJ

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

2. Starting T_{ch} = 25°C, V_{DD} = 150 V, R_G = 25 Ω , V_{GS} = 20 \rightarrow 0 V

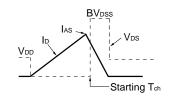
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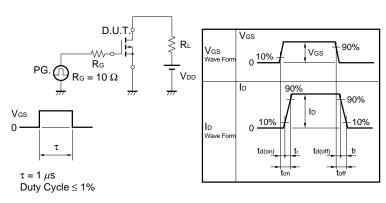
ELECTRICAL CHARACTERISTICS (TA = 25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	Ioss	Vps = 800 V, Vgs = 0 V			100	μΑ
Gate Leakage Current	Igss	Vgs = ±30 V, Vps = 0 V			±100	nA
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	2.5		3.5	V
Forward Transfer Admittance	yfs	V _{DS} = 10 V, I _D = 3.0 A	2.0			S
Drain to Source On-state Resistance	RDS(on)	Vgs = 10 V, ID = 3.0 A		1.8	2.2	Ω
Input Capacitance	Ciss	V _{DS} = 10 V		1220		pF
Output Capacitance	Coss	Vgs = 0 V		170		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		16		pF
Turn-on Delay Time	td(on)	V _{DD} = 150 V, I _D = 3.0 A		17		ns
Rise Time	tr	Vgs = 10 V		7		ns
Turn-off Delay Time	t _{d(off)}	$R_G = 10 \Omega$		43		ns
Fall Time	tf			11		ns
Total Gate Charge	QG	V _{DD} = 450 V		25		nC
Gate to Source Charge	Qgs	Vgs = 10 V		6		nC
Gate to Drain Charge	Q _{GD}	ID = 6.0 A		10		nC
Body Diode Forward Voltage	V _F (S-D)	IF = 6.0 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 6.0 A, VGS = 0 V		1490		ns
Reverse Recovery Charge	Qrr	di/dt = 50 A/ μs		7.5		μC

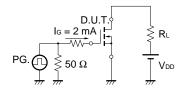
TEST CIRCUIT 1 AVALANCHE CAPABILITY



TEST CIRCUIT 2 SWITCHING TIME



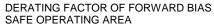
TEST CIRCUIT 3 GATE CHARGE

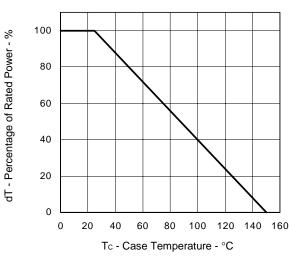




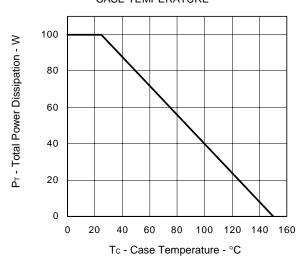
lo - Drain Current - A

TYPICAL CHARACTERISTICS (TA = 25°C)

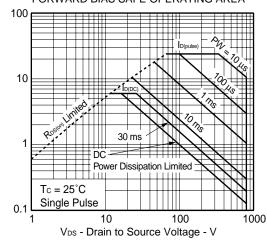




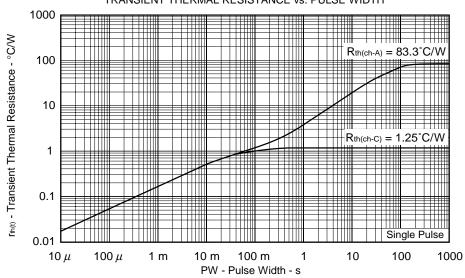
TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



FORWARD BIAS SAFE OPERATING AREA

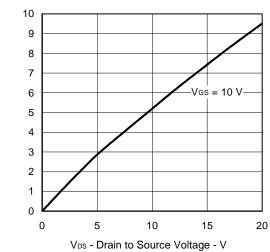


TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

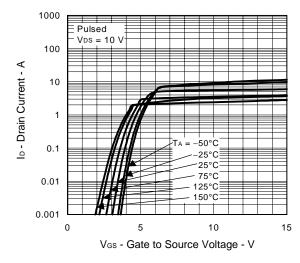


lo - Drain Current - A

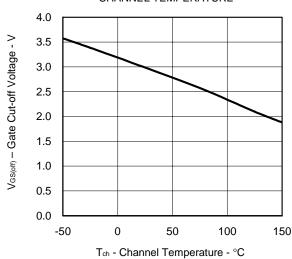
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



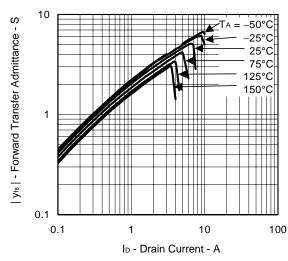
FORWARD TRANSFER CHARACTERISTICS



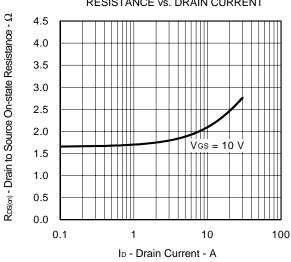
GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



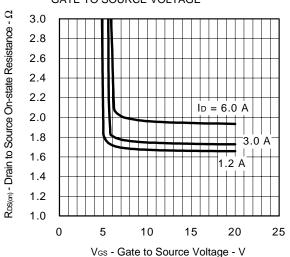
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



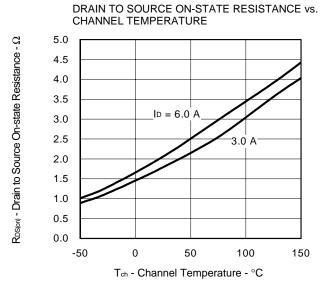
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

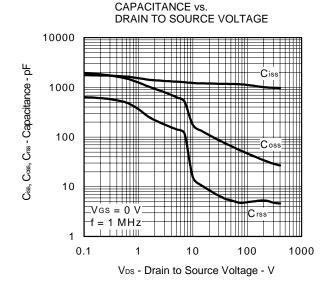


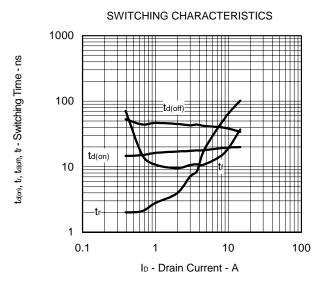
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

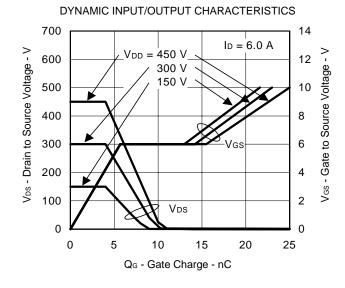


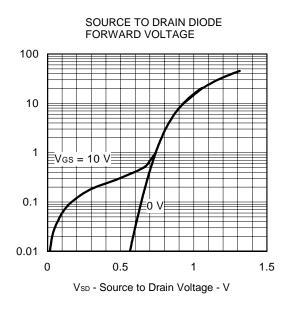




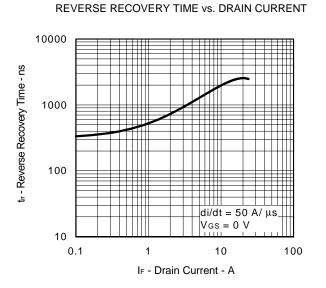




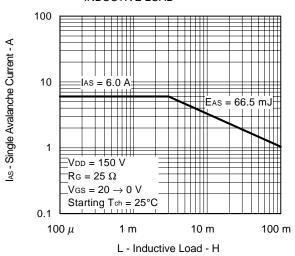




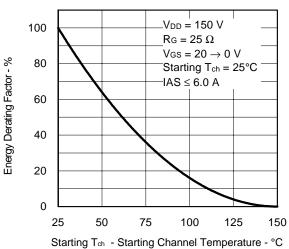
Isp - Diode Forward Current - A



SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD

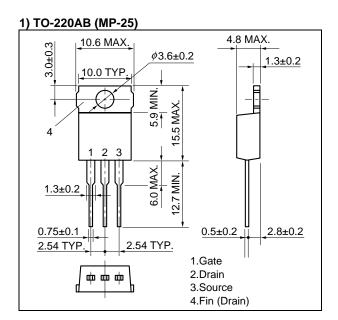


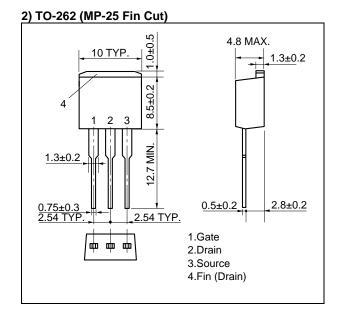
SINGLE AVALANCHE ENERGY **DERATING FACTOR**



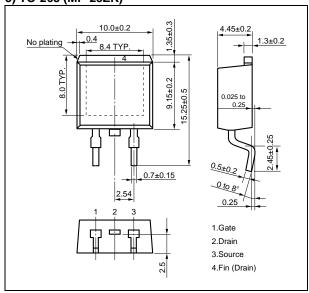


PACKAGE DRAWINGS (Unit: mm)

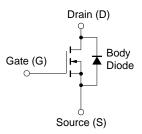




3) TO-263 (MP-25ZK)



EQUIVALENT CIRCUIT



Remark Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

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